

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**PRELIMINARY AMENDMENT ACCOMPANYING APPLICATION**

APPLICANT: Akira Yoshizawa, et al.

ATTY. DOCKET NO. 09792909-5237

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INVENTION: "SEMICONDUCTOR DEVICE USING INTERPOSER SUBSTRATE AND  
MANUFACTURING METHOD THEREFOR"

Assistant Commissioner of Patents  
Washington, D.C. 20231

S I R:

Between the title and the heading "Background of the Invention" on page 1, insert the  
following:

--RELATED APPLICATION DATA

The present application claims priority to Japanese Application(s) No(s). P2000-309506  
filed October 10, 2000, and P2001-147024 filed May 16, 2001, which application(s) is/are  
incorporated herein by reference to the extent permitted by law.--

Respectfully submitted,

 (Reg. No. 45,034)

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